

the specification of which DATA PROCESSOR AND DATA PROCESSING METHOD



DECLARATION FOR PATENT APPLICATION (JOINT OR SOLE) (Under 37 CFR § 1.63; with Power of Attorney) FROMMER LAWRENCE & HAUG LLP FLH File No. x

As a below named inventor, I hereby declare that:

As a below named inventor, I nereby declare that:

My residence, post office address and citizenship are as stated below next to my name,
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the, subject matter which is claimed and for which a patent is sought on the invention ENTITLED:

		•		
x is attached hereto.				
was filed on as Ap	plication Serial No,			
with amendment(s) through	(if applicable, give dates).			
I hereby state that I have reviewed above.	and understand the contents of the abov	e-identified specification, including the claims	, as amended by a	ny amendment referred to
l acknowledge the duty to disclose 37, Code of Federal Regulations, Sec. 1.56.	e to the United States Patent and Tradema	ark Office all information known to me to be r	naterial to patentab	pility as defined in Title
have also identified below any foreign application	nefits under Title 35, United States Code, on for patent or inventor's certificate have additional applications on separate page	§ 119 of any foreign application(s) for patenting a filing date before that of the application of	or inventor's certifon which priority is Priority Clair	s claimed:
Number:	Country:	Filed (Day/Month/Year):	Yes	<u>No</u>
9927111.6	UK	16 November 1999	x	
I hereby claim the benefit under T claims of this application is not disclosed in the the duty to disclose to the United States Patent a Regulations, Sec. 1.56, which became available Prior U.S. Application(s) [list additions]	prior United States application in the ma and Trademark Office all information kno between the filing date of the prior appli	own to me to be material to patentability as de	5, United States Co fined in Title 37, C	ode § 112, I acknowledge Code of Federal
Appin, Ser, Number:	Filed (Day/Month/Year):	Status (patented, pending	abandoned):	
further that these statements were made with the of Title 18 of the United States Code and that states INVENTOR(S):	Esq. t HAUG LLP is made herein of my own knowledge are e knowledge that willful false statements uch willful false statements	Direct all telephone calls to: (212) 588-0800 to the attention of: WILLIAM S. FROMMER true and that all statements made on informat and the like so made are punishable by fine or ze the validity of the application or any patent	r imprisonment, or issued thereon.	believed to be true; and both, under Section 100
Signature:	icraft	Date: 25(10	œ	
Full name of sole or first inventor: Mark Residence: 42 Ly	k John McGrath Idbury, Harmanswater, Bracknell, Berksh d Kingdom			
Signature:		Date:		
Full name of 2nd joint inventor (if any): x Residence: Citizenship:				
Signature:		Date:		
Full name of 3rd joint inventor (if any): x Residence: Citizenship:				
[Similarly list additional inventors on separate Post Office Address(es) of inventor(s): [if different from residence]	page] Sony Corporation 7-35 Kitashinagawa 6-chome Shinagawa-Ku, Tokyo, Japan			
Note: In order to qualify for reduced fees avail separate "Verified Statement (Declaration) Cla Nonprofit Organization, individual Non-Invent	iming [or Supporting a Claim by Another	any other individual or entity having rights to r for] Small Entity Status" form [e.g. for Indep	the invention must endent Inventor, S	t also sign an appropriate mall Business Concern,

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